

Past Exhibitors

5S Components Inc.

Aalborg University

ABB Inc.

Abstract Power Electronics

Advanced MotorTech

Altair

ANSYS, Inc.

Cambridge University Press

Change Proto Lamination to Proto Lam, Inc.

C-Motive Technologies

Concordia University

Cramer Magnetics

CURRENT

Danfoss Drives

Eaton Corporation

ELANTAS PDG, Inc.

Electronic Concepts, Inc

EMWorks Inc.

EPCOS Inc.

FREEDM

GaN Systems

General Motors

GMW Associates

HBM Test and Measurement

How2Power.com

HVR Advanced Power Components Inc.

IEEE Industry Applications Society (IAS)

IEEE Power Electronics Society (PELS)

Infineon Technologies Americas Corp.

Infolytica

Keysight Technologies

LEM USA Inc.

MagneForce Software Systems, Inc.

MathWorks

Mersen

Mesago PCIM GmbH

Myway Plus Corporation

NPIE Bridge Program

Ohio State University

OPAL RT

Payton America Inc

Plexim, Inc

Powerex, Inc

Powersim Inc.

Powersys Inc.

Proto Laminations, Inc.

Rockwell Automation

Teledyne LeCroy

Texas A&M

Typhoon HIL, Inc.

Univ. of NC Charlotte - EPIC

Univ. of Wisconsin - Madison

VisIC Technologies

Wolfspeed

Wolong Electric Group Co. Ltd.

Yokogawa

ZES ZIMMER Inc.

Zunum Aero